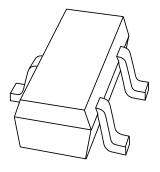
DISCRETE SEMICONDUCTORS

DATA SHEET



BFR520TNPN 9 GHz wideband transistor

Product specification Supersedes data of 1999 Nov 02 2000 Apr 03



NPN 9 GHz wideband transistor

BFR520T

FEATURES

- · High power gain
- · Low noise figure
- · High transition frequency
- Gold metallization ensures excellent reliability
- SOT416 (SC-75) package.

APPLICATIONS

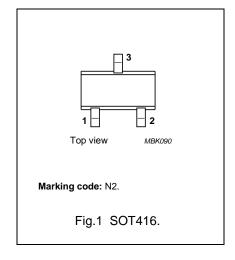
Wideband applications such as satellite TV tuners, cellular phones, cordless phones, pagers etc., with signal frequencies up to 2 GHz.

DESCRIPTION

Silicon NPN transistor encapsulated in a plastic SOT416 (SC-75) package.

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	_	20	V
V _{CES}	collector-emitter voltage	R _{BE} = 0	_	-	15	V
I _C	DC collector current		_	-	70	mA
P _{tot}	total power dissipation	up to T _s = 75 °C; note 1	-	-	150	mW
h _{FE}	DC current gain	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; T_j = 25 ^{\circ}\text{C}$	60	120	250	
f _T	transition frequency	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 1 \text{ GHz};$ $T_{amb} = 25 \text{ °C}$	_	9	_	GHz
G _{UM}	maximum unilateral power gain	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 900 \text{ MHz}; $ $T_{amb} = 25 \text{ °C}$	_	15	-	dB
F	noise figure	$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V}; f = 900 \text{ MHz}; $ $T_{amb} = 25 \text{ °C}$	_	1.1	1.6	dB

Note

1. T_s is the temperature at the soldering point of the collector tab.

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	20	V
V _{CES}	collector-emitter voltage	$R_{BE} = 0$	_	15	V
V_{EBO}	emitter-base voltage	open collector	_	2.5	V
I _C	DC collector current		-	70	mA
P _{tot}	total power dissipation	up to T _s = 75 °C; note 1	-	150	mW
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		_	150	°C

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Note

1. T_s is the temperature at the soldering point of the collector tab.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	500	K/W

CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector cut-off current	I _E = 0; V _{CE} = 6 V	_	_	50	nA
h _{FE}	DC current gain	I _C = 20 mA; V _{CE} = 6 V	60	120	250	
C _e	emitter capacitance	$I_C = i_c = 0$; $V_{EB} = 0.5 \text{ V}$; $f = 1 \text{ MHz}$	_	1	-	pF
C _c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = 6 \text{ V}$; $f = 1 \text{ MHz}$	_	0.5	_	pF
C _{re}	feedback capacitance	I _C = 0; V _{CB} = 6 V; f = 1 MHz	_	0.4	_	pF
f _T	transition frequency	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 1 \text{ GHz};$ $T_{amb} = 25 \text{ °C}$	-	9	-	GHz
G _{UM}	maximum unilateral power gain; note 1	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 900 \text{ MHz};$ $T_{amb} = 25 \text{ °C}$	-	15	-	dB
		$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 2 \text{ GHz}; $ $T_{amb} = 25 \text{ °C}$	-	9	-	dB
s ₂₁ ²	insertion power gain	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 900 \text{ MHz};$ $T_{amb} = 25 \text{ °C}$	13	14	_	dB
F	noise figure	$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 5$ mA; $V_{\text{CE}} = 6$ V; $f = 900$ MHz; $T_{\text{amb}} = 25$ °C	_	1.1	1.6	dB
		$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 20$ mA; $V_{\text{CE}} = 6$ V; $f = 900$ MHz; $T_{\text{amb}} = 25$ °C	_	1.6	2.1	dB
		$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 5$ mA; $V_{\text{CE}} = 6$ V; $f = 2$ GHz; $T_{\text{amb}} = 25$ °C	-	1.9	-	dB
P _{L1}	output power at 1 dB gain compression	I_C = 20 mA; V_{CE} = 6 V; R_L = 50 Ω ; f = 900 MHz; T_{amb} = 25 °C	-	17	-	dBm
ITO	third order intercept point	note 2	_	26	-	dBm

Notes

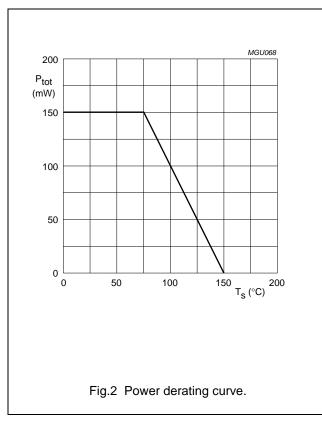
1. $\,\,G_{UM}$ is the maximum unilateral power gain, assuming s_{12} is zero and

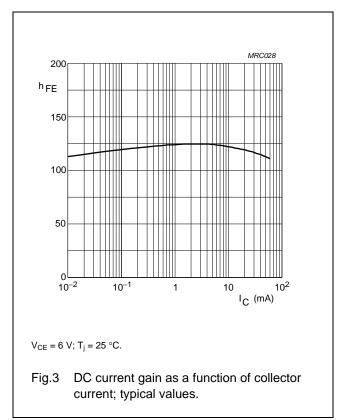
$$G_{UM} = 10 \log \frac{|s_{21}|^2}{(1 - |s_{11}|^2)(1 - |s_{22}|^2)} dB$$

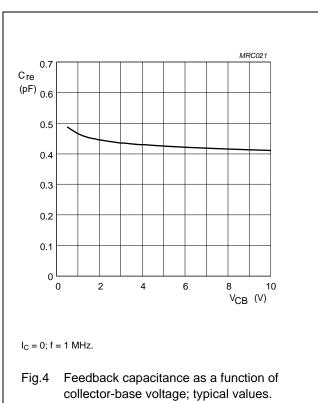
2. I_C = 20 mA; V_{CE} = 6 V; R_L = 50 Ω ; f = 900 MHz; T_{amb} = 25 °C; f_p = 900 MHz; f_q = 902 MHz; measured at $f_{(2p-q)}$ = 898 MHz and at $f_{(2q-p)}$ = 904 MHz.

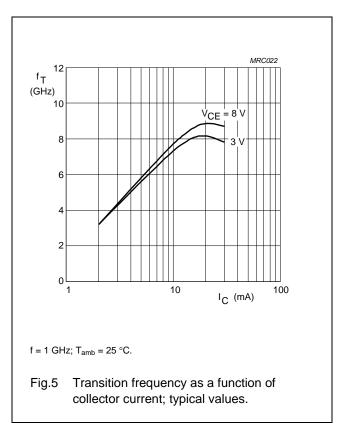
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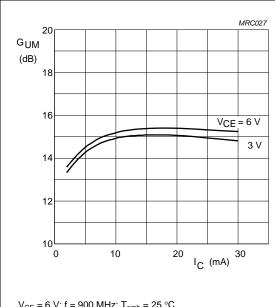






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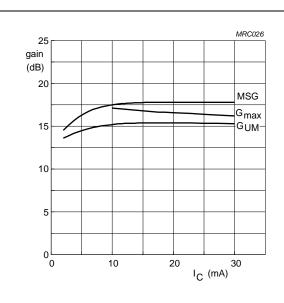


 V_{CE} = 6 V; f = 900 MHz; T_{amb} = 25 °C.

 G_{UM} = maximum unilateral power gain. MSG = maximum stable gain.

 G_{max} = maximum available gain.

Fig.6 Maximum unilateral power gain as a function of collector current; typical values.

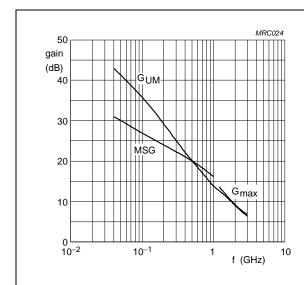


 V_{CE} = 6 V; f = 2 GHz; T_{amb} = 25 °C.

G_{UM} = maximum unilateral power gain. MSG = maximum stable gain.

 G_{max} = maximum available gain.

Gain as a function of collector current; typical values.

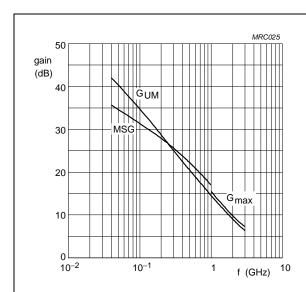


 I_{C} = 5 mA; V_{CE} = 6 V; T_{amb} = 25 °C. G_{UM} = maximum unilateral power gain.

MSG = maximum stable gain.

G_{max} = maximum available gain.

Fig.8 Gain as a function of frequency; typical values.



 I_{C} = 20 mA; V_{CE} = 6 V; T_{amb} = 25 °C. G_{UM} = maximum unilateral power gain.

typical values.

MSG = maximum stable gain. G_{max} = maximum available gain.

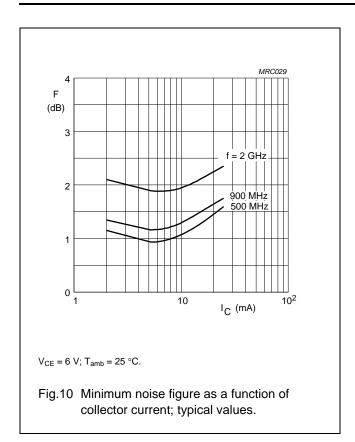
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Fig.9 Gain as a function of frequency;

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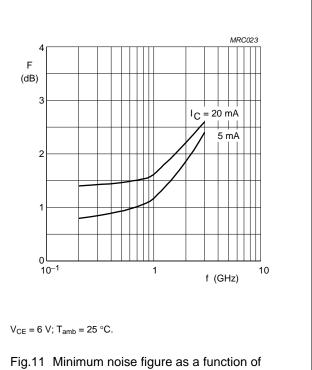
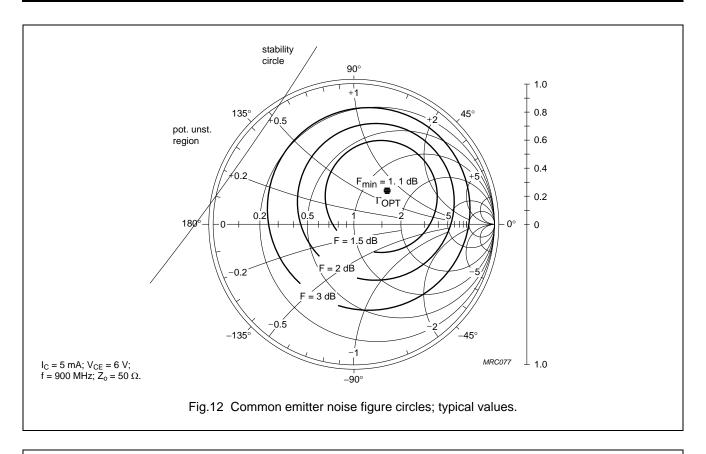
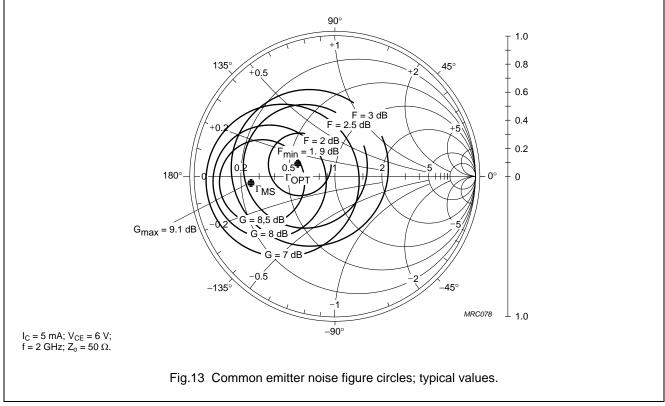


Fig.11 Minimum noise figure as a function of frequency; typical values.

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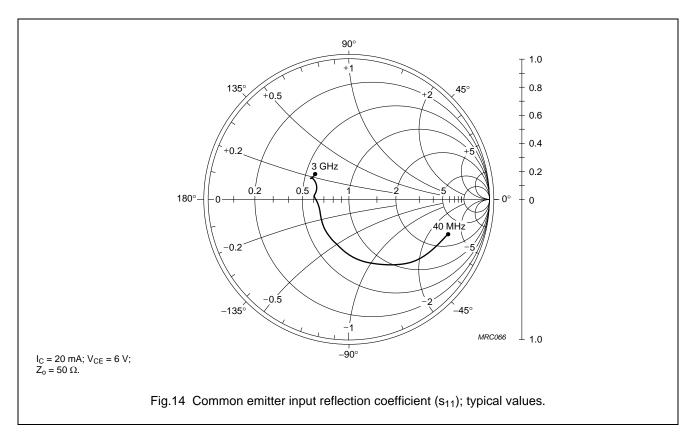
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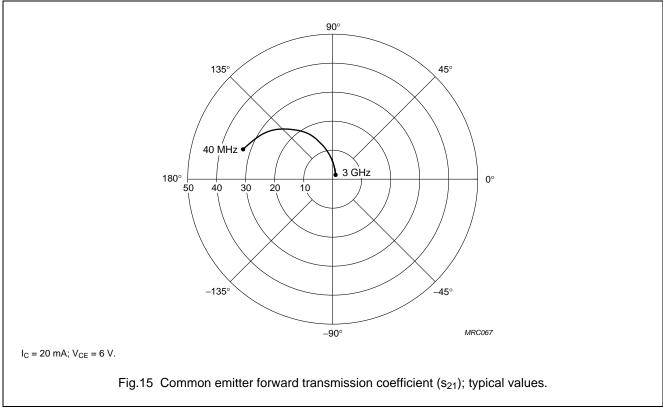




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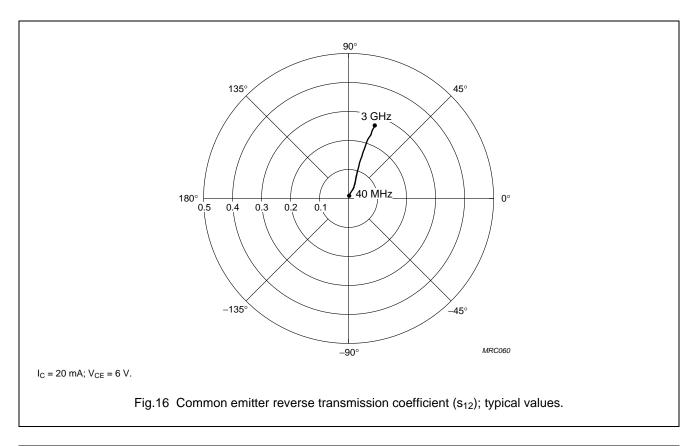
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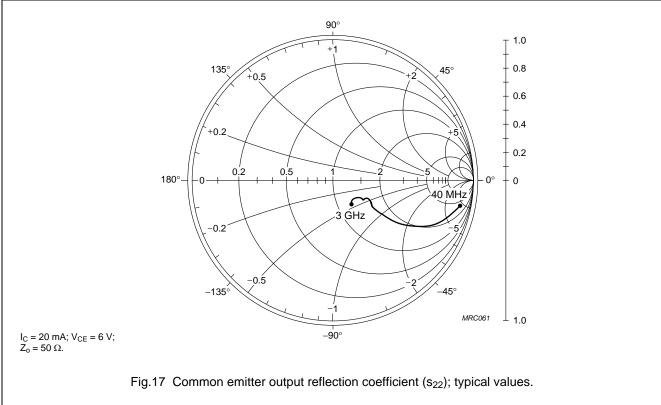




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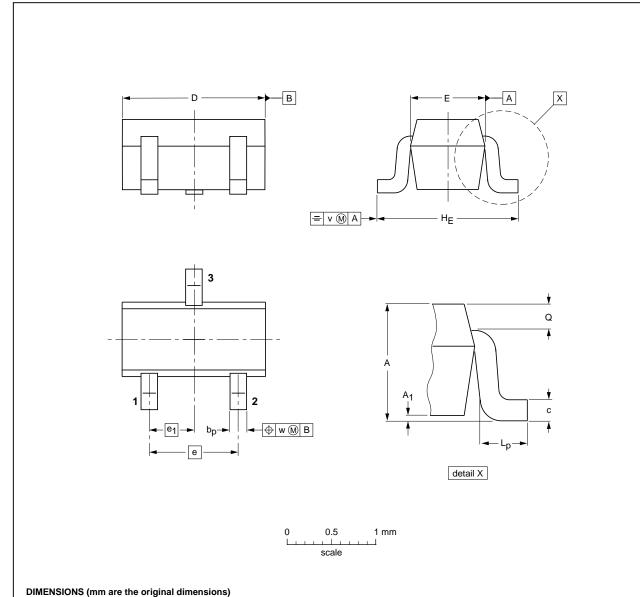
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PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT416



VERSION IEC JEDEC JEITA PROJECTION ISSUE	DAIL
SOT416 SC-75 C-75	

 $\mathbf{H}_{\mathbf{E}}$

1.75 1.45 L_{p}

0.45

0.15

Q

0.23

w

Ε

0.9 0.7 е

D

1.8 1.4

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UNIT

 mm

max

0.1

0.95

0.60

0.30 0.15 0.25 0.10

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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